

### Description

The 6N135, 6N136, ICPL450X series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon high speed photo transistor in a plastic DIP8 package with different lead forming options.

A separate design between photodiode and transistor reduces the base-collector capacitance of the input transistor which improves the speed by several orders of magnitude over conventional phototransistor optocouplers.

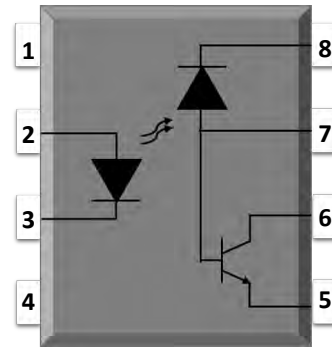
### Features

- High isolation 5000 VRMS
- DC input with transistor output
- Operating temperature range - 55 °C to 100 °C
- REACH compliance
- Halogen free (Optional)
- MSL class 1
- Regulatory Approvals
  - UL - UL1577
  - VDE - EN60747-5-5(VDE0884-5)
  - CQC - GB4943.1, GB8898
  - cUL- CSA Component Acceptance Service Notice No. 5A

### Applications

- Line receivers
- Telecommunication equipment
- Out interface to CMOS-LSTTL-TTL
- Wide bandwidth analog coupling
- Pulse transformer replacement
- Computer-peripheral interface

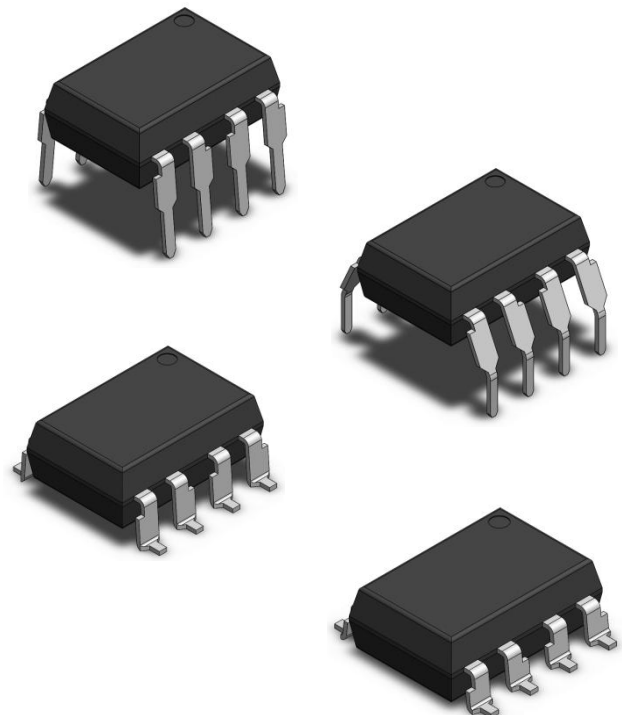
### SCHEMATIC

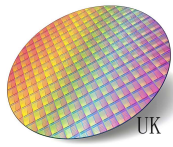


### PIN DEFINITION

<b>1.NC</b>	<b>8.VCC</b>
<b>2.Anode</b>	<b>7.VB(for 6N135/6N136)</b> <b>NC(for TD4502/TD4503)</b>
<b>3.Cathode</b>	<b>6.VO</b>
<b>4.NC</b>	<b>5.GND</b>

### OUTLINE





**ABSOLUTE MAXIMUM RATINGS**

PARAMETER	SYMBOL	VALUE	UNIT	Note
<b>INPUT</b>				
Forward Current	$I_F$	25	mA	
Peak Forward Current	$I_{FP}$	50	mA	1
Peak Transient Current	$I_{F(trans)}$	1	A	2
Reverse Voltage	$V_R$	5	V	
Input Power Dissipation	$P_I$	100	mW	
<b>OUTPUT</b>				
Supply Voltage	$V_{CC}$	-0.5~30	V	
Output Voltage	$V_O$	-0.5~20	V	
Output Current	$I_O$	50	mA	
Emitter-Base Reverse Voltage	$V_{EBR}$	5	V	
Base Current	$I_B$	5	mA	
Output Power Dissipation	$P_O$	100	mW	
<b>COMMON</b>				
Total Power Dissipation	$P_{tot}$	200	mW	
Isolation Voltage	$V_{iso}$	5000	V <sub>rms</sub>	3
Operating Temperature	$T_{opr}$	-55~100	°C	
Storage Temperature	$T_{stg}$	-55~150	°C	
Soldering Temperature	$T_{sol}$	260	°C	4

Note 1. 50% duty, 1ms P.W

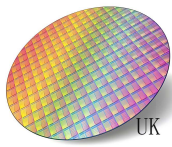
Note 2.  $\leq 1\mu s$  P.W,300pps

Note 3. AC For 1 Minute, R.H. = 40 ~ 60%

Note 4. For 10 seconds

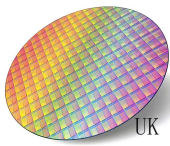
**ELECTRICAL OPTICAL CHARACTERISTICS**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION	NOTE
INPUT(at Ta=0 to 70°C , unless specified otherwise)							
Forward Voltage	$V_F$	-	1.45	1.8	V	$I_F=16\text{mA}$	
Reverse Current	$I_R$	-	-	10	$\mu\text{A}$	$V_R=5\text{V}$	
Input Capacitance	$C_{in}$	-	60	-	pF	$V=0, f=1\text{MHz}$	
OUTPUT(at Ta=0 to 70°C , unless specified otherwise)							
High Level Supply Current	$I_{CCH}$	-	0.01	1	$\mu\text{A}$	$I_F=0\text{mA}, V_O=\text{Open}, V_{CC}=15\text{V}, T_a=25^\circ\text{C}$	
		-	-	2	$\mu\text{A}$	$I_F=0\text{mA}, V_O=\text{Open}, V_{CC}=15\text{V}$	
Low Level Supply Current	$I_{CCL}$	-	200	-	$\mu\text{A}$	$I_F=16\text{mA}, V_O=\text{Open}, V_{CC}=15\text{V}$	
Logic High Output Current	$I_{OH}$	-	0.001	0.5	$\mu\text{A}$	$I_F=0\text{mA}, V_O=V_{CC}=5.5\text{V}, T_a=25^\circ\text{C}$	
		-	0.01	1	$\mu\text{A}$	$I_F=0\text{mA}, V_O=V_{CC}=15\text{V}, T_a=25^\circ\text{C}$	
		-	-	50	$\mu\text{A}$	$I_F=0\text{mA}, V_O=V_{CC}=15\text{V}$	



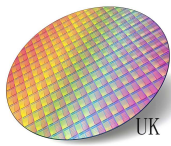
**ELECTRICAL OPTICAL CHARACTERISTICS**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION	NOTE	
TRANSFER CHARACTERISTICS(at Ta=0 to 70°C , unless specified otherwise)								
Current Transfer Ratio	6N135	7	-	50	%	I <sub>F</sub> = 16mA ,V <sub>O</sub> = 0.4V, V <sub>CC</sub> =4.5V, Ta=25°C		
	6N136	19	-	50				
	4502							
	4503							
Current Transfer Ratio	6N135	5	-	-	%	I <sub>F</sub> = 16mA ,V <sub>O</sub> = 0.5V, V <sub>CC</sub> =4.5V		
	6N136	15	-	-				
	4502							
	4503							
Logic Low Output Voltage	6N135	-	0.18	0.4	μA	I <sub>F</sub> = 16mA ,I <sub>O</sub> = 1.1mA, V <sub>CC</sub> =4.5V, Ta=25°C		
	6N136	-	0.25	0.4			μA	I <sub>F</sub> = 16mA ,I <sub>O</sub> = 3mA, V <sub>CC</sub> =4.5V, Ta=25°C
	4502							
	4503							
Logic Low Output Voltage	6N135	-	-	0.5	μA	I <sub>F</sub> = 16mA ,I <sub>O</sub> =0.8mA, V <sub>CC</sub> =4.5V		
	6N136	-	-	0.5			μA	I <sub>F</sub> = 16mA ,I <sub>O</sub> =2.4mA, V <sub>CC</sub> =4.5V
	4502							
	4503							
Isolation Resistance	R <sub>iso</sub>	10 <sup>12</sup>	10 <sup>14</sup>	-	Ω	DC500V, 40 ~ 60% R.H.		
Floating Capacitance	C <sub>IO</sub>	-	0.3	1	pF	V=0, f=1MHz		



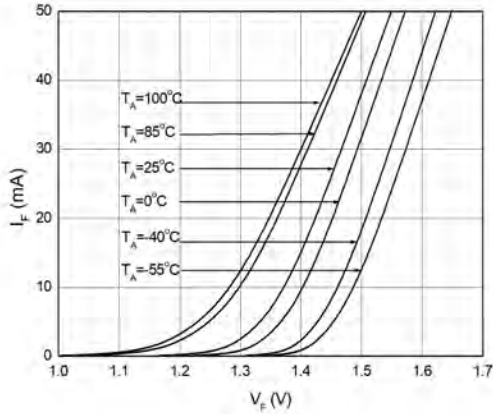
**ELECTRICAL OPTICAL CHARACTERISTICS**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION	NOTE	
SWITCHING CHARACTERISTICS(at Ta=0 to 70°C, I <sub>F</sub> =16mA, V <sub>CC</sub> =5V, unless specified otherwise)								
Propagation Delay Time to Logic Low	6N135	TPHL	-	0.35	1.5	μs	R <sub>L</sub> =4.1kΩ, T <sub>A</sub> =25°C	Fig.13
			-	-	2		R <sub>L</sub> =4.1kΩ	
	6N136 4502 4503		-	0.35	0.8		R <sub>L</sub> =1.9kΩ, T <sub>A</sub> =25°C	
			-	-	1.0		R <sub>L</sub> =1.9kΩ	
Propagation Delay Time to Logic High	6N135	TPLH	-	0.5	1.5	μs	R <sub>L</sub> =4.1kΩ, T <sub>A</sub> =25°C	Fig.13
			-	-	2		R <sub>L</sub> =4.1kΩ	
	6N136 4502 4503		-	0.3	0.8		R <sub>L</sub> =1.9kΩ, T <sub>A</sub> =25°C	
			-	-	1.0		R <sub>L</sub> =1.9kΩ	
Common Mode Transient Immunity at Logic High	6N135	CM <sub>H</sub>	1000	-	-	V/μs	I <sub>F</sub> = 0mA, V <sub>CM</sub> =10Vpp, R <sub>L</sub> =4.1kΩ, T <sub>A</sub> =25°C	Fig.14
	6N136 4502		1000	-	-		I <sub>F</sub> = 0mA, V <sub>CM</sub> =10Vpp, R <sub>L</sub> =1.9kΩ, T <sub>A</sub> =25°C	
	4503		15000	20000	-		I <sub>F</sub> = 0mA, V <sub>CM</sub> =1500Vpp, R <sub>L</sub> =1.9kΩ, T <sub>A</sub> =25°C	
Common Mode Transient Immunity at Logic Low	6N135	CM <sub>L</sub>	1000	-	-	V/μs	I <sub>F</sub> = 16mA, V <sub>CM</sub> =10Vpp, R <sub>L</sub> =4.1kΩ, T <sub>A</sub> =25°C	Fig.14
	6N136 4502		1000	-	-		I <sub>F</sub> = 16mA, V <sub>CM</sub> =10Vpp, R <sub>L</sub> =1.9kΩ, T <sub>A</sub> =25°C	
	4503		15000	20000	-		I <sub>F</sub> = 16mA, V <sub>CM</sub> =1500Vpp, R <sub>L</sub> =1.9kΩ, T <sub>A</sub> =25°C	

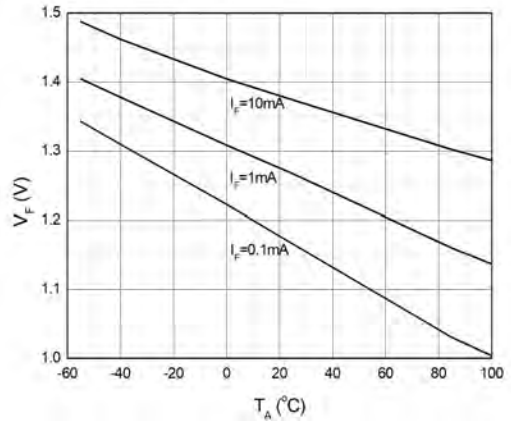


**CHARACTERISTIC CURVES**

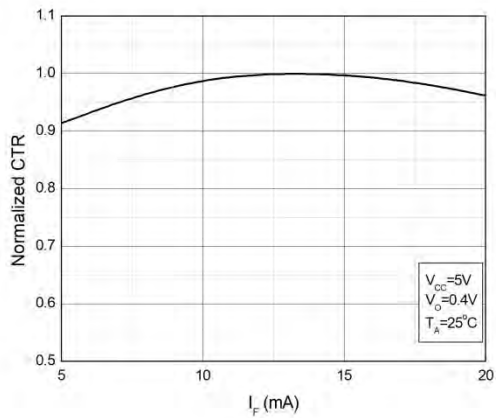
**Fig.1 Forward Current vs. Forward Voltage**



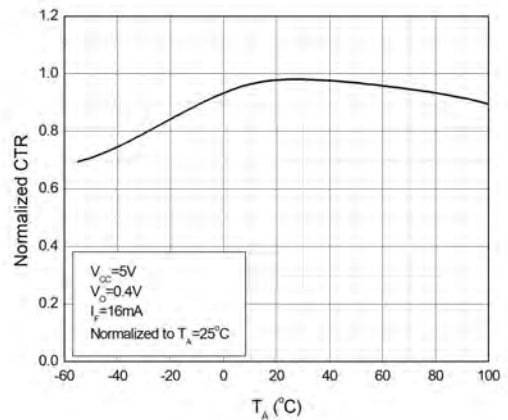
**Fig.2 Forward Voltage vs. Ambient Temperature**



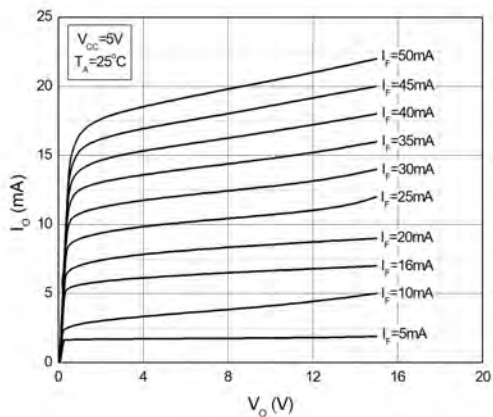
**Fig.3 Input Threshold Current vs. Ambient Temperature**



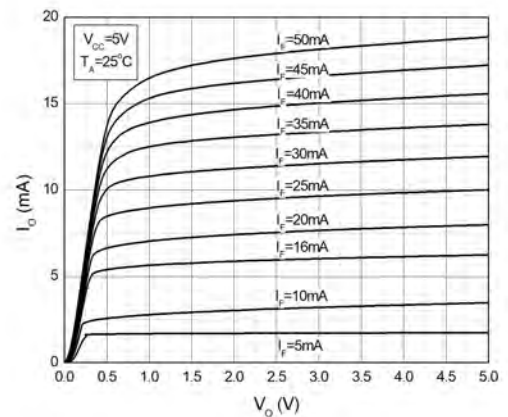
**Fig.4 Input Threshold Current vs. Ambient Temperature**



**Fig.5 Low Level Output Current vs. Ambient Temperature**

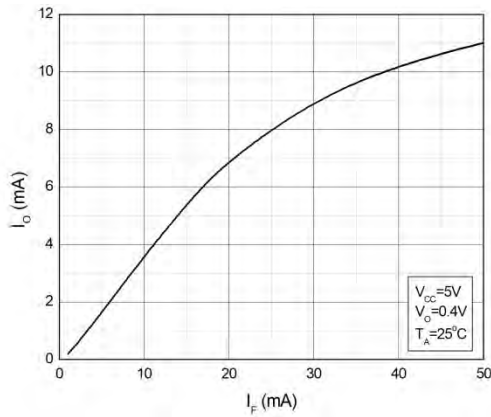


**Fig.6 Low Level Output Current vs. Ambient Temperature**

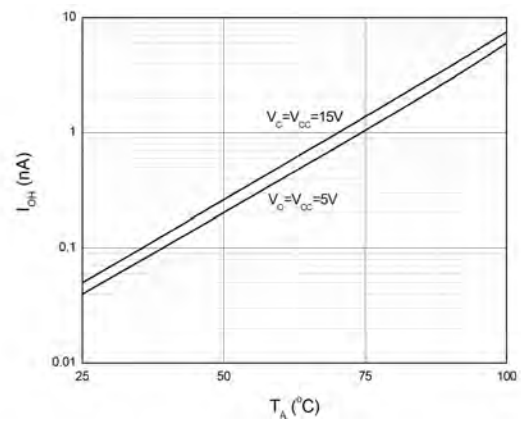


**CHARACTERISTIC CURVES**

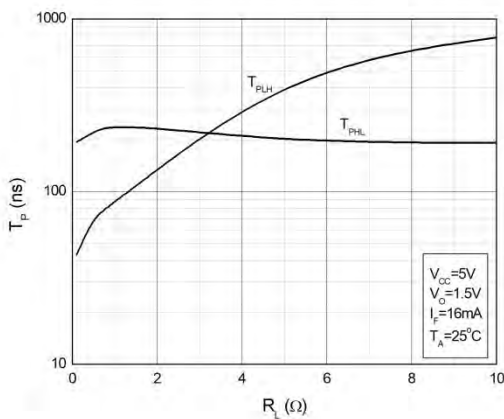
**Fig.7 Low Level Output Voltage vs. Ambient Temperature**



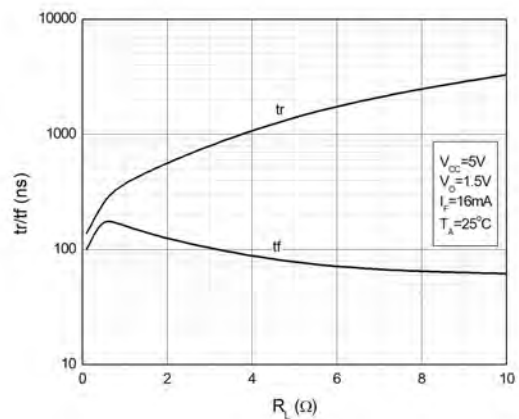
**Fig.8 Low Level Output Voltage vs. Ambient Temperature**



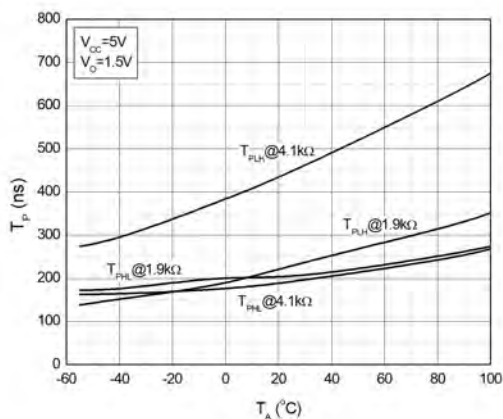
**Fig.9 High Level Output Current vs. Ambient Temperature**



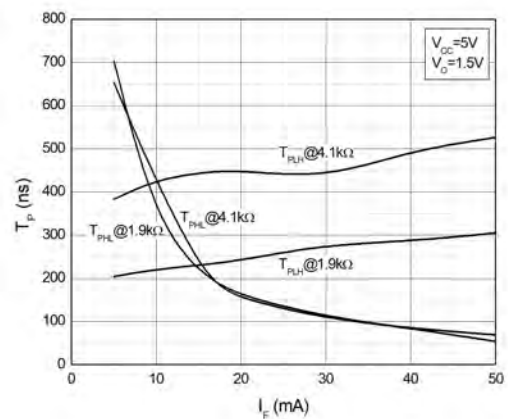
**Fig.10 High Level Output Current vs. Ambient Temperature**



**Fig.11 Output Voltage vs. Forward Current**

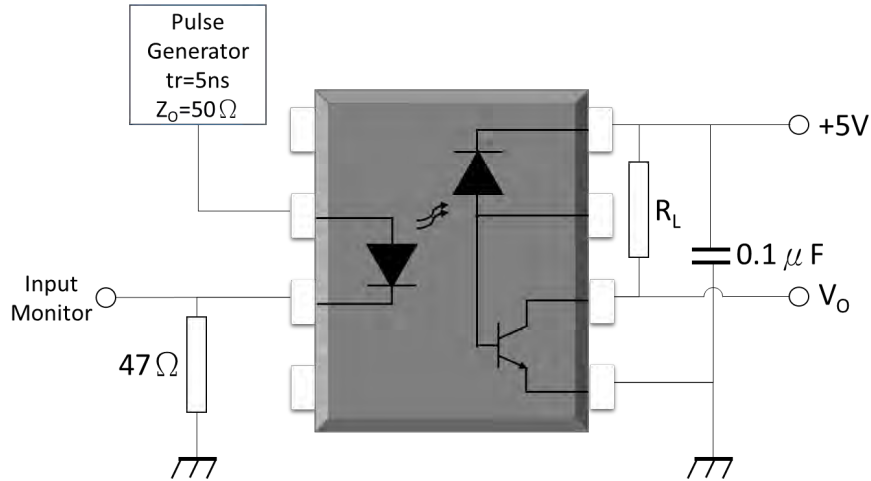


**Fig.12 Output Voltage vs. Forward Current**

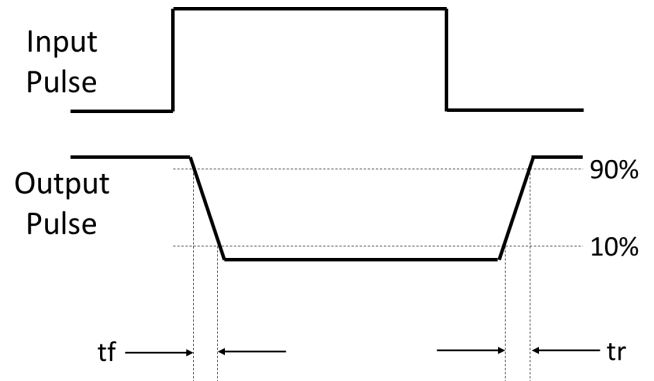
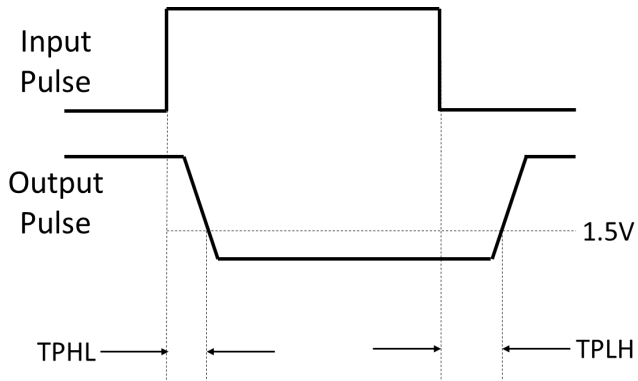


**TEST CIRCUITS**

**Fig.13 Test Circuits for TPHL, TPLH, tr, tf**



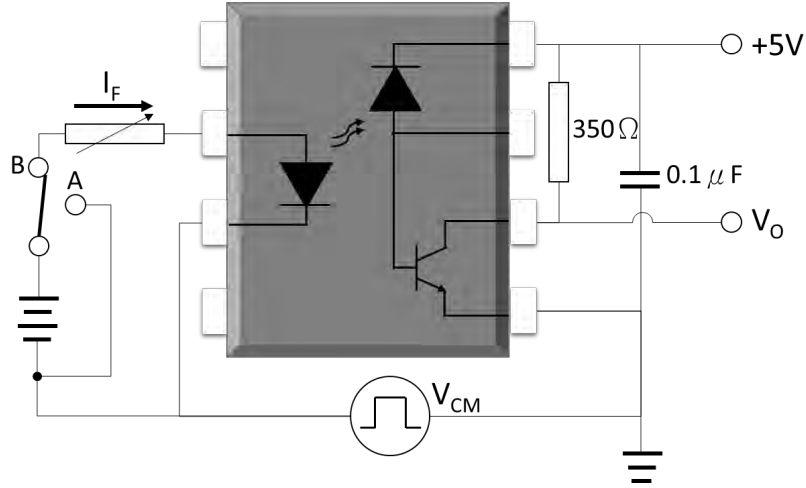
**Fig.14 Waveforms of TPHL, TPLH, tr, tf**



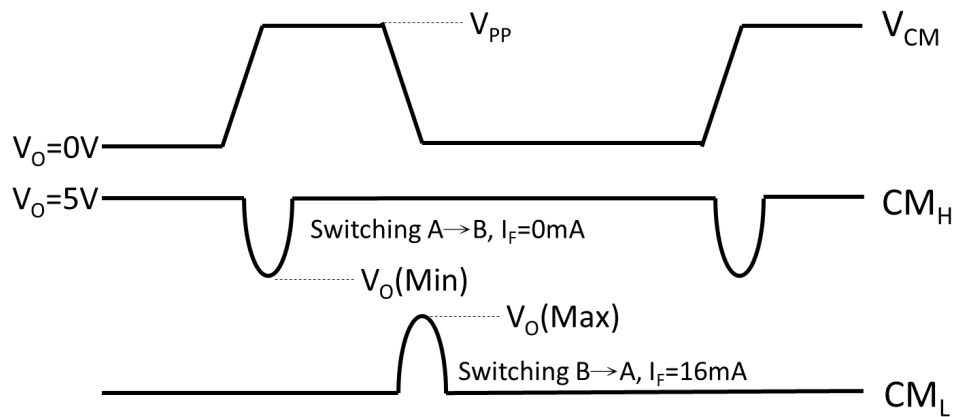


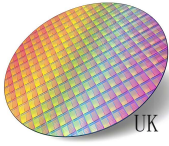
**TEST CIRCUITS**

**Fig.15 Test Circuits for Common Mode Transient Immunity**



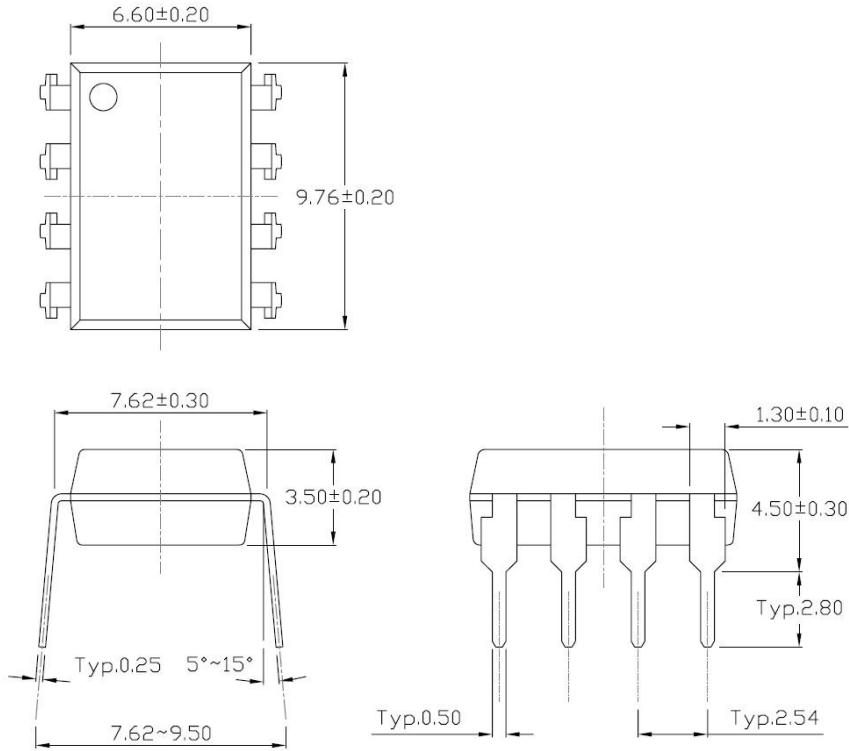
**Fig.16 Waveforms of Common Mode Transient Immunity**



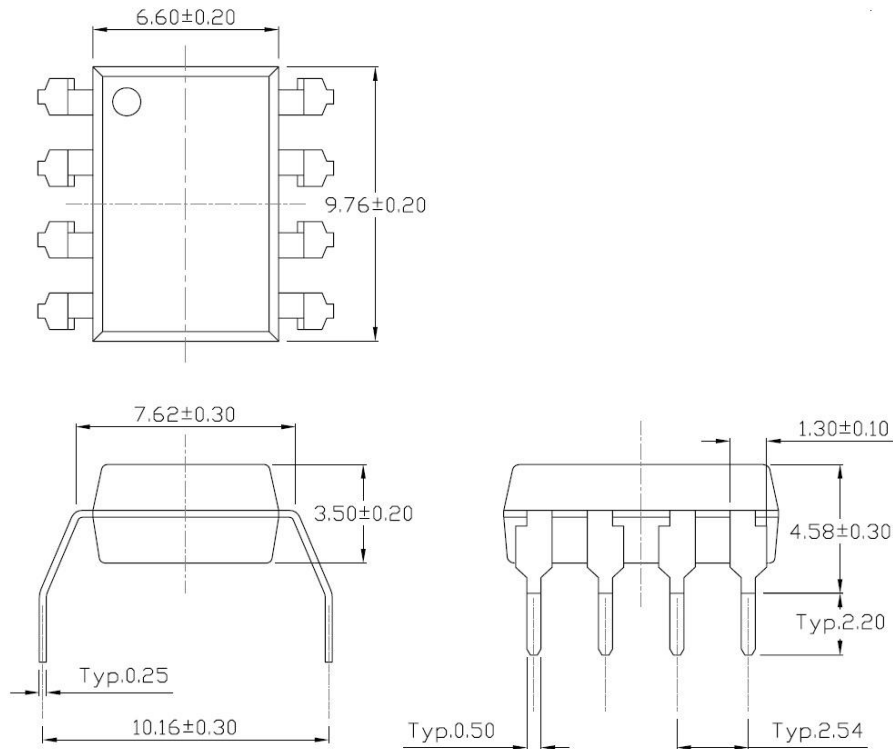


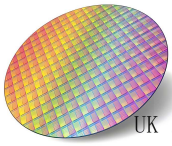
**PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)**

**Standard DIP – Through Hole (DIP Type)**



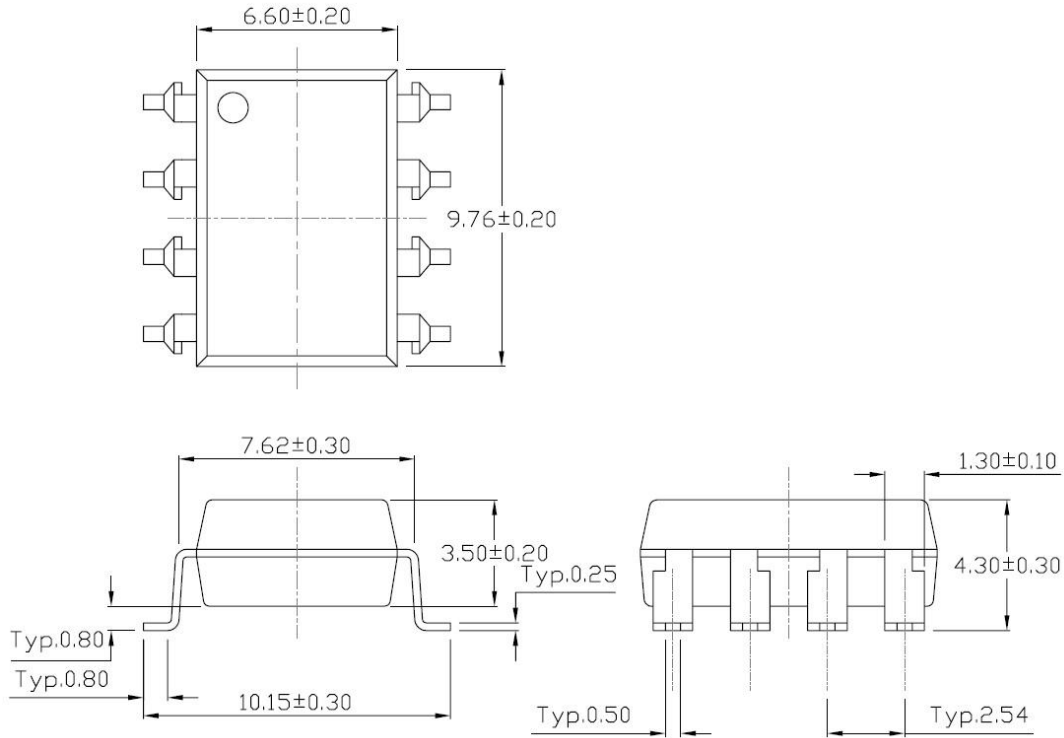
**Gullwing (400mil) Lead Forming – Through Hole (M Type)**



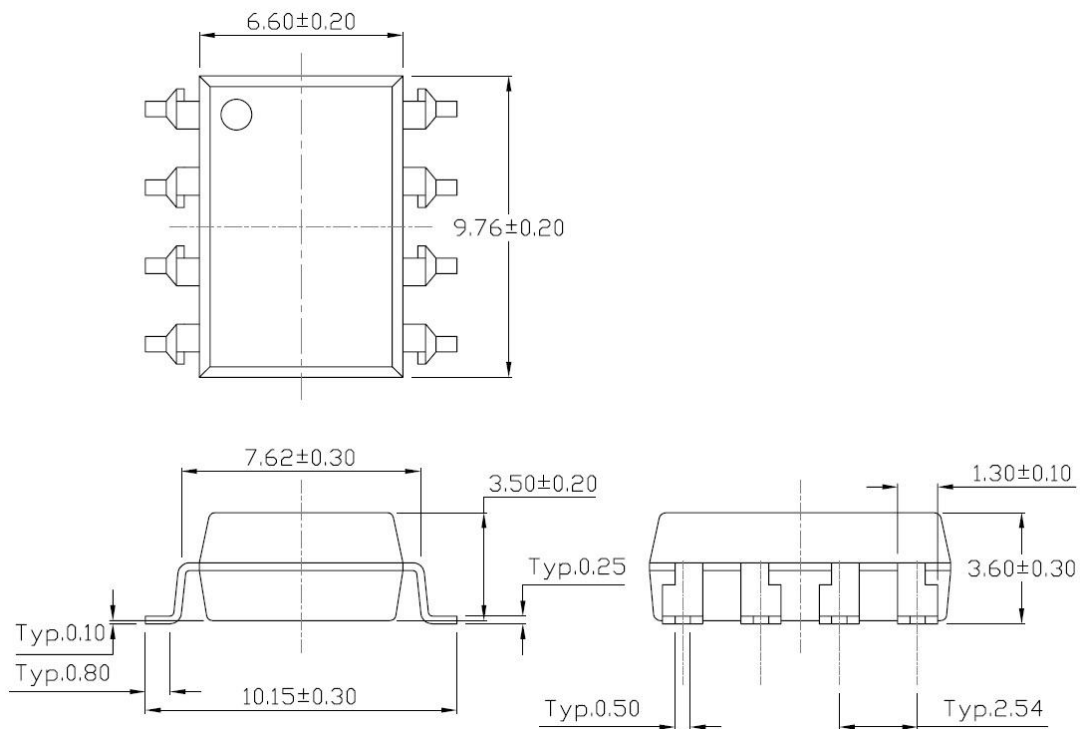


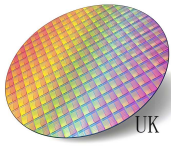
**PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)**

**Surface Mount Lead Forming (SM Type)**



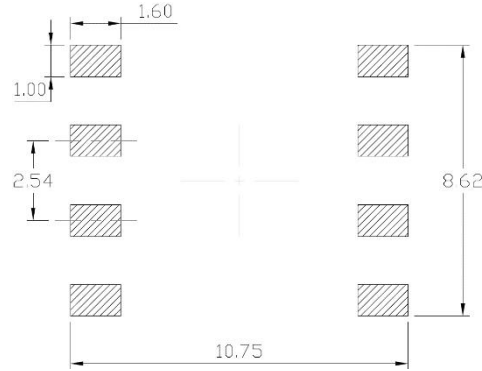
**Surface Mount (Low Profile) Lead Forming (SL Type)**



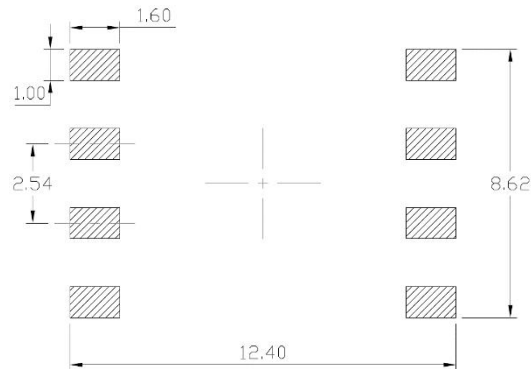


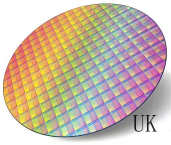
**Recommended Solder Mask (Dimensions in mm unless otherwise stated)**

**Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming**



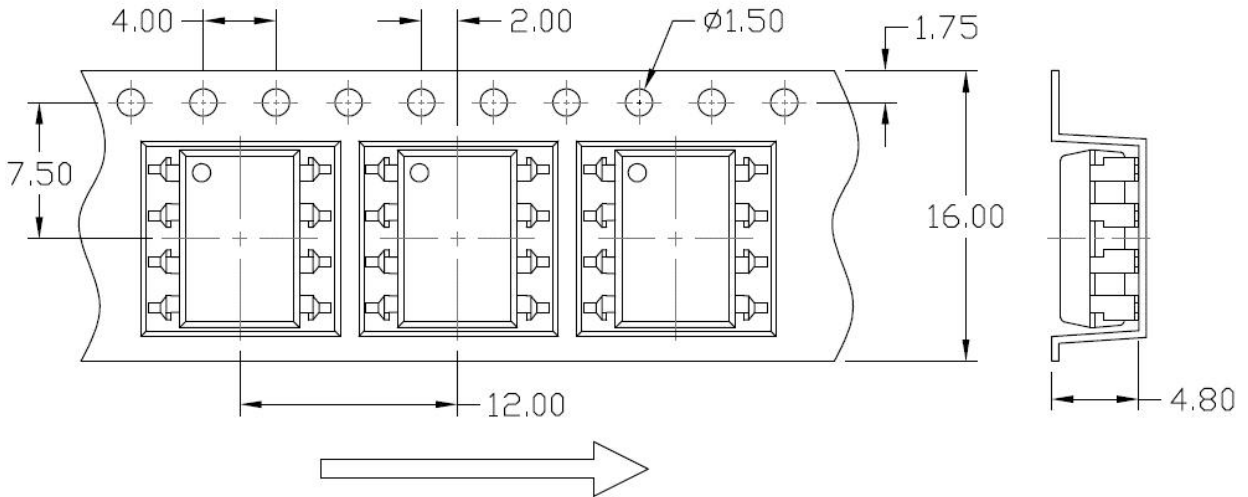
**Surface Mount (Gullwing) Lead Forming**



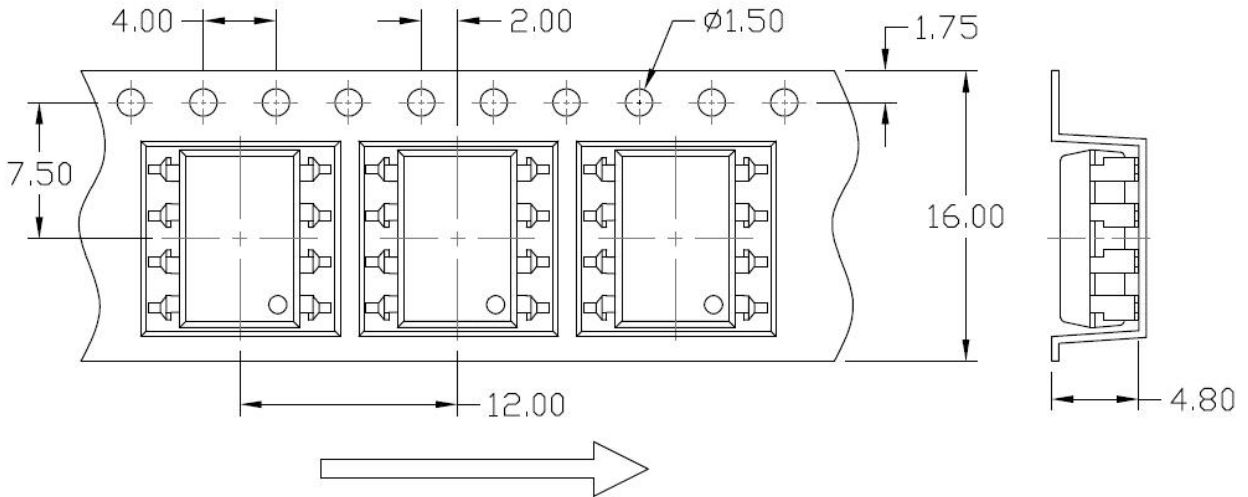


**Carrier Tape Specifications (Dimensions in mm unless otherwise stated)**

**Option SM(T1) & SL(T1)**

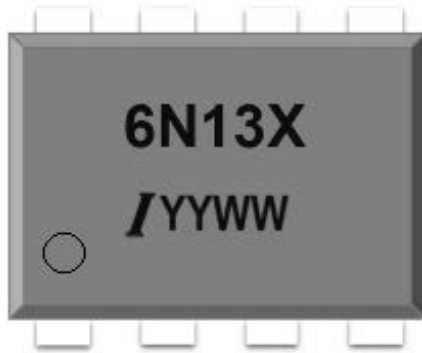


**Option SM(T2) & SL(T2)**



**ORDERING AND MARKING INFORMATION**

**MARKING INFORMATION**



**6N13X** : Part Number  
**/** : Company Abbr.  
**YY** : Year  
**WW** : Work Week

**ORDERING INFORMATION**

**LABEL INFORMATION**

**6N13X(L)(T&R)-V**

6N13X – Part Number (X=5 or 6)

L – Lead Form Option

(M/SM/SL/None)

T&R – Tape and Reel Option (T1/T2)

V – VDE Option (V or None)

**PACKING QUANTITY**

Option	Description	Quantity
None	Standard 8 Pin Dip	50Units/Tube
M	Gullwing(400mil) Lead Forming	50Units/Tube
SM(T1)	Surface Mount Lead Forming – With Option 1 Taping	1000 Units/Reel
SM(T2)	Surface Mount Lead Forming – With Option 2 Taping	1000 Units/Reel
SL(T1)	Surface Mount Lead Forming(Low Profile) – With Option 1 Taping	1000 Units/Reel
SL(T2)	Surface Mount Lead Forming(Low Profile) – With Option 2 Taping	1000 Units/Reel

**ORDERING AND MARKING INFORMATION**

**MARKING INFORMATION**



**ICPL450X** : Part Number & Rank  
**/** : Company Abbr.  
**Y** : Year  
**WW** : Work Week

**ORDERING INFORMATION**

**LABEL INFORMATION**

**ICPL450X(L)(T&R)-V**

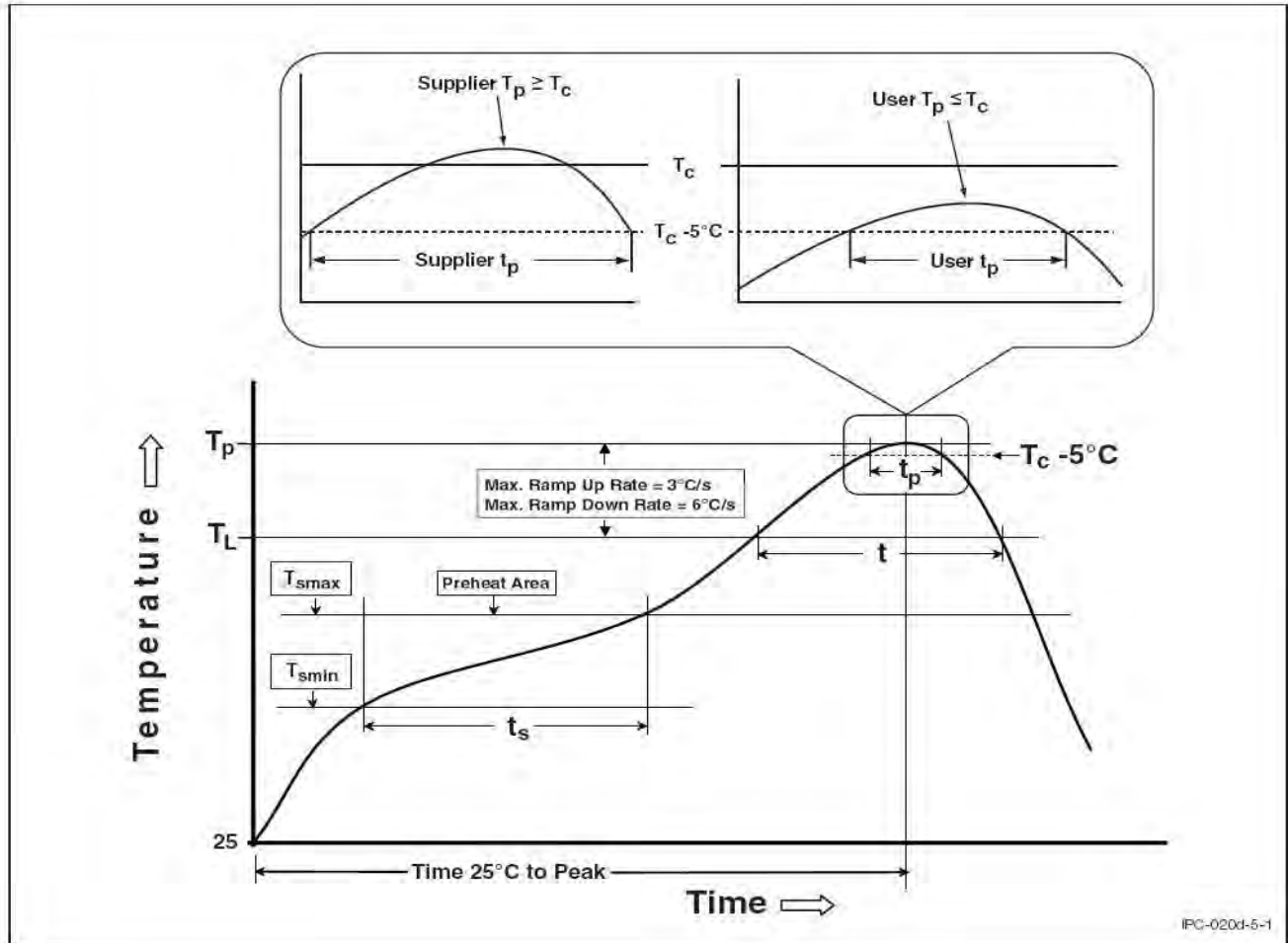
ICPL450X – Rank (X=2 or 3)  
 L – Lead Form Option  
 (M/SM/SL/None)  
 T&R– Tape and Reel Option (T1/T2)  
 V – VDE Option (V or None)

**PACKING QUANTITY**

Option	Description	Quantity
None	Standard 8 Pin Dip	50Units/Tube
M	Gullwing(400mil) Lead Forming	50Units/Tube
SM(T1)	Surface Mount Lead Forming – With Option 1 Taping	1000 Units/Reel
SM(T2)	Surface Mount Lead Forming – With Option 2 Taping	1000 Units/Reel
SL(T1)	Surface Mount Lead Forming(Low Profile) – With Option 1 Taping	1000 Units/Reel
SL(T2)	Surface Mount Lead Forming(Low Profile) – With Option 2 Taping	1000 Units/Reel

**REFLOW INFORMATION**

**REFLOW PROFILE**



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. ( $T_{smin}$ )	100	150°C
Temperature Max. ( $T_{smax}$ )	150	200°C
Time ( $t_s$ ) from ( $T_{smin}$ to $T_{smax}$ )	60-120 seconds	60-120 seconds
Ramp-up Rate ( $t_L$ to $t_P$ )	3°C/second max.	3°C/second max.
Liquidous Temperature ( $T_L$ )	183°C	217°C
Time ( $t_L$ ) Maintained Above ( $T_L$ )	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time ( $t_P$ ) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate ( $T_P$ to $T_L$ )	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



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- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact ASG sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated in each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify ASG's terms and conditions of purchase, including but not limited to the warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.